#### **IN THE SPECIFICATION:**

Page 1, line 5, insert the following topic headings:

## **BACKGROUND OF THE INVENTION**

### FIELD OF THE INVENTION

Page 1, line 8, insert the following topic heading:

## THE PRIOR ART

Page 2, line 11, insert the following topic heading:

# **SUMMARY OF THE INVENTION**

Page 9, line 27 to page 10, replace the Table with the following amended Table.

Composition of the dispersion	Concentration as % by weight
Titanium dioxide as finely divided powder	5 to 25
Dioxane	10 to 30
2-methoxy-1-methylethyl acetate	25 to 40
Mixture of dipropylene glycol methyl ether	1 to 15
isomers	
Disperse-ayd® w33 1)	0.2 to 2
Joncryl® 537 2)	5 to 25
Mixture of tripropylene glycol methyl ether	1 to 5
isomers	
Dapro ® u99 3)	0.25 to 1
Palladium-Copper (II) chloride (metallic salt)	0.05 to 1
Citric Acid (sequestering agent)	0.1 to 1
Ammonia (base)	0.1 to 1
Deionised water	1 to 15

66345-036-7 Serial No. 10/541,210 Amendment dated June 19, 2007 Reply to Office Action of June 4,2006

Page 10, lines 11 to 14, replace the paragraph with the following amended paragraph.

The same procedure as in Example 1 is followed. The result is the deposition of a catalytic <u>palladium-copper</u> layer, selective or not. In the case of a selective metallisation, the non-irradiated parts are solubilised in water. A metallic overloading by electroplating is then made possible.